Electronic Acknowledgement Receipt				
EFS ID:	1362848			
Application Number:	10599175			
International Application Number:				
Confirmation Number:	5398			
Title of Invention:	CONDUCTIVE THERMOPLASTIC-RESIN FILM AND CONDUCTIVE THERMOPLASTIC-RESIN LAMINATE FILM			
First Named Inventor/Applicant Name:	Michinari Miyagawa			
Customer Number:	7278			
Filer:	Marie Louise Collazo/Mami Hasegawa			
Filer Authorized By:	Marie Louise Collazo			
Attorney Docket Number:	09871/0205474-US0			
Receipt Date:	08-DEC-2006			
Filing Date:				
Time Stamp:	17:27:43			
Application Type:	U.S. National Stage under 35 USC 371			

Payment information:

Submitted with Payment	no	
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Documents submitted with 371 Applications	00940385.PDF	12130	no	1
Warnings:					

Information:							
2	Substitute Drawings	00940388.PDF	11758	no	2		
Warnings:							
Information	:						
Total Files Size (in bytes):		:	23888				

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.